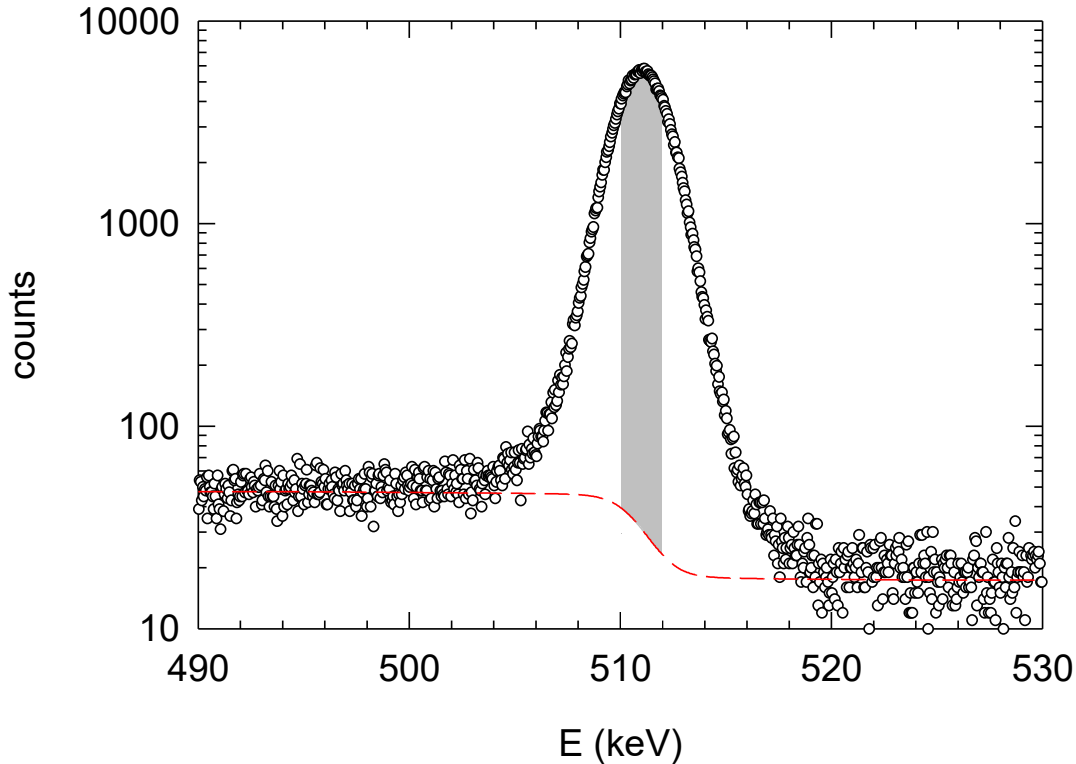


Doppler broadening – shape parameters



- S parameter

$$S = A_{centr} / A_{tot}$$

$$S = \eta_B S_B + \sum_i \eta_{D_i} S_{D_i}$$

free e^+

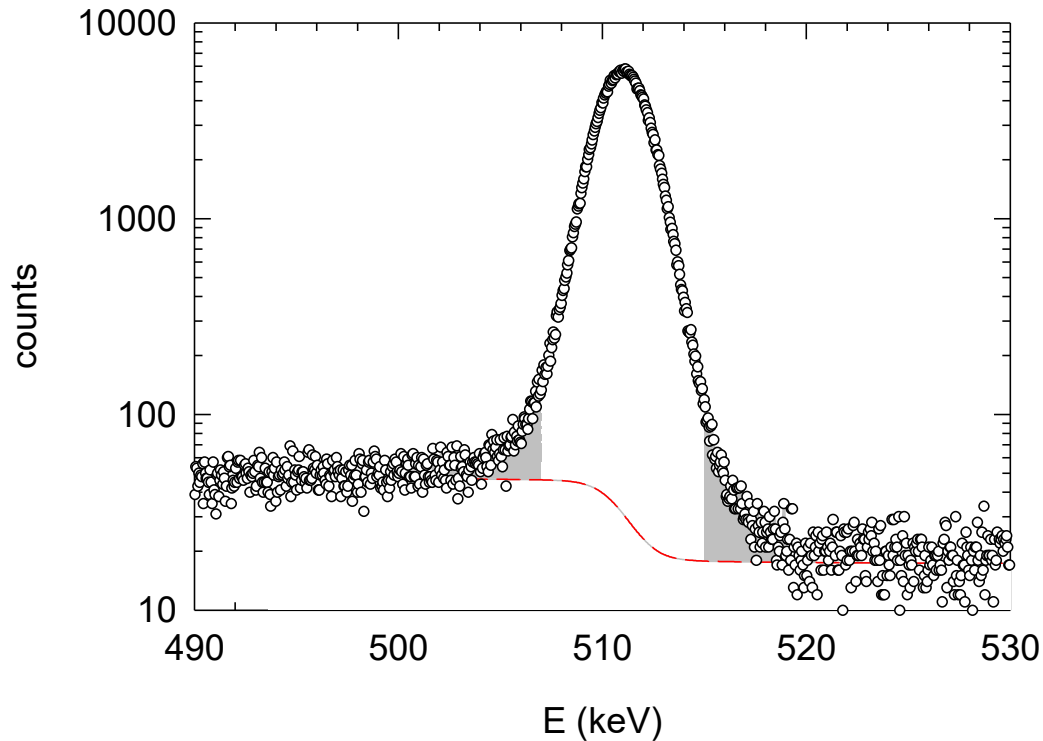
e^+ trapped
at defects

- S – a measure of e^+ annihilations with valence e^- (low ΔE)
- increase of defect concentration \rightarrow increase of S parameter

- reference sample: $S_0 \approx 0.5$

- normalization: S / S_0

Doppler broadening – shape parameters



- W – a measure of e^+ annihilations with core e^- (high ΔE)
- increase of defect concentration \rightarrow decrease of W parameter

- W parameter

$$W = A_{wings} / A_{tot}$$

$$W = \eta_B W_B + \sum_i \eta_{D_i} W_{D_i}$$

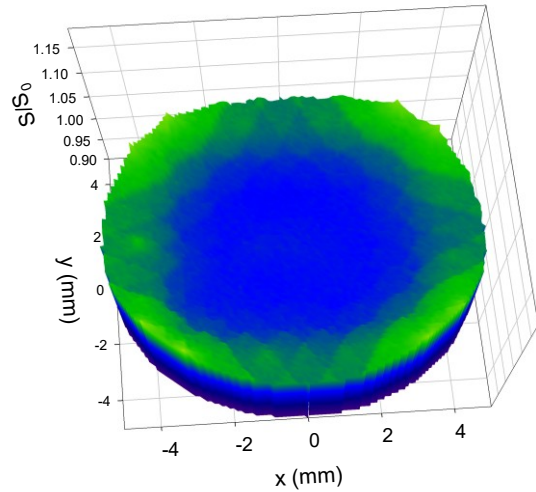
free e^+

e^+ trapped
at defects

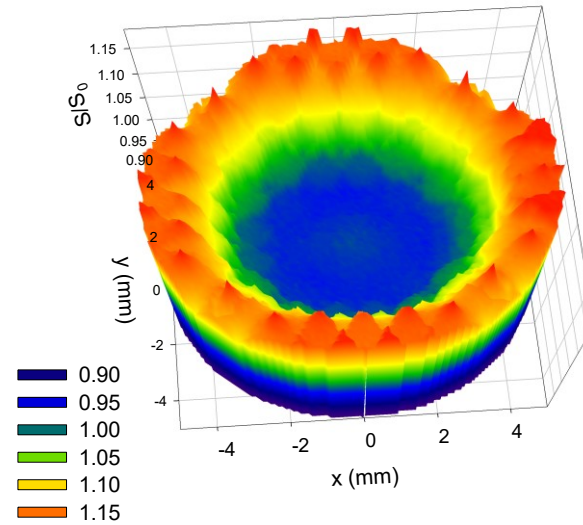
- reference sample: $W_0 \approx 0.03$
- normalization: W / W_0

Doppler broadening – shape parameters

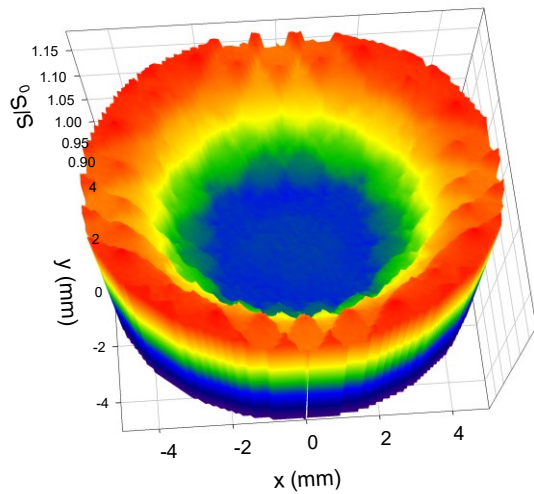
1 HPT revolution



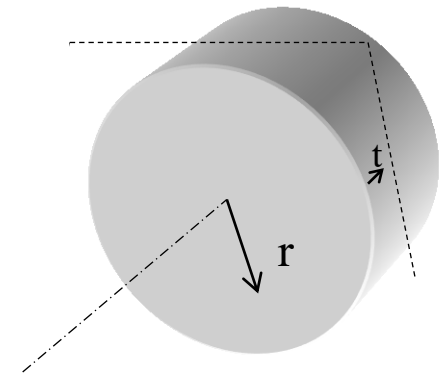
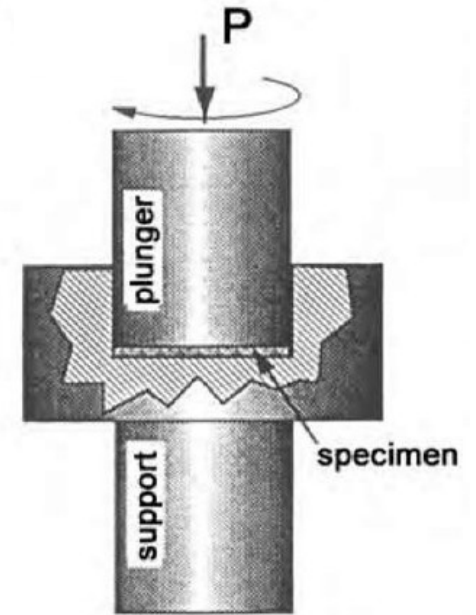
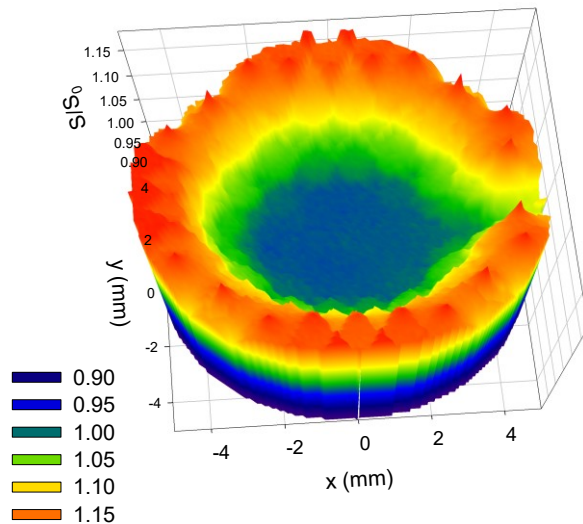
3 HPT revolutions



15 HPT revolutions

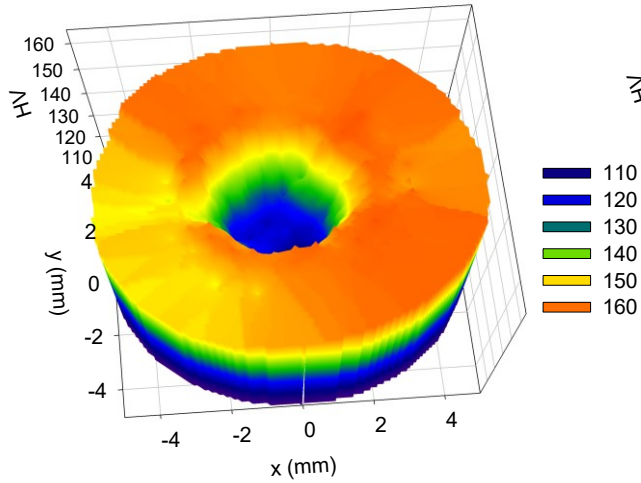


25 HPT revolutions

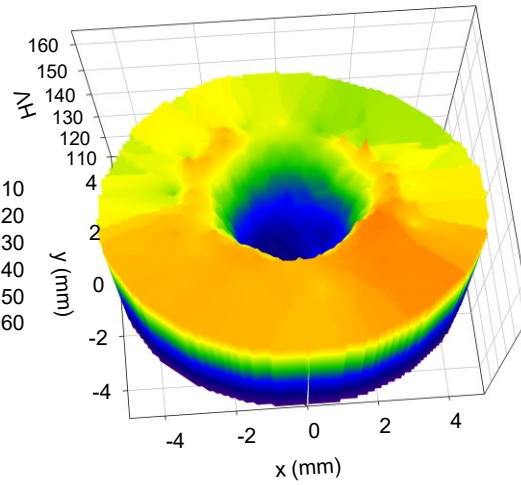


Comparison with microhardnes

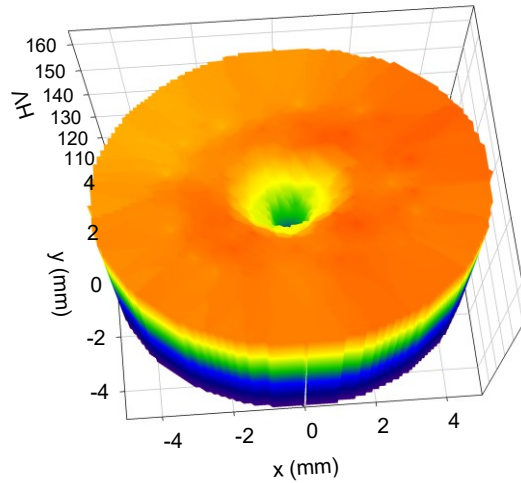
1 HPT revolution



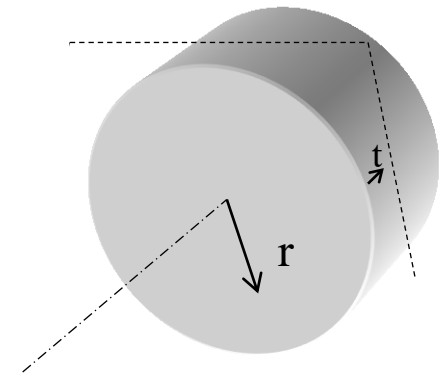
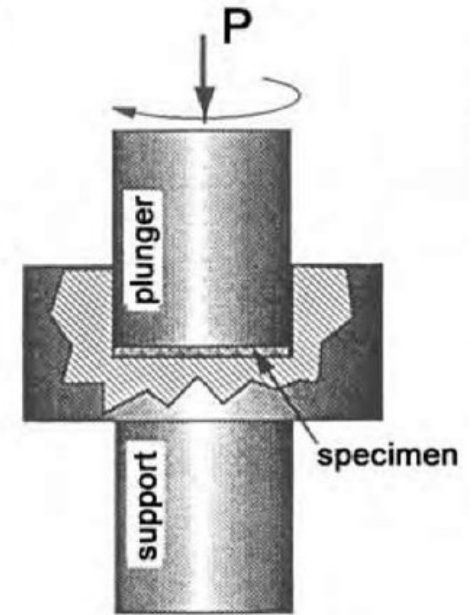
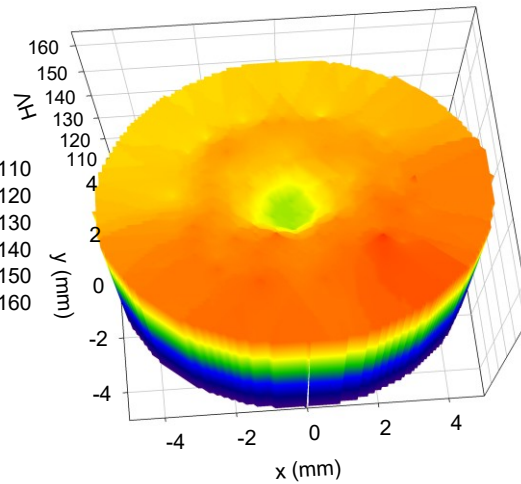
3 HPT revolutions



15 HPT revolutions



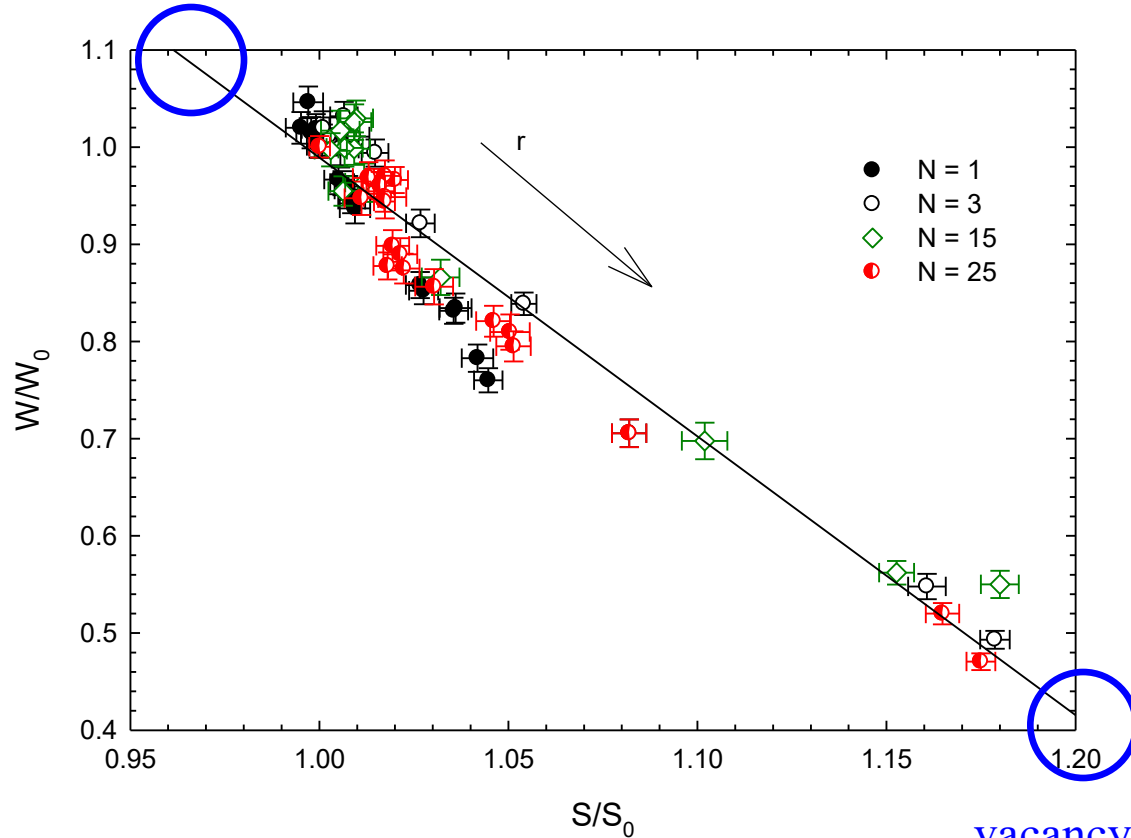
25 HPT revolutions



S-W plot

dislocations

HPT Cu



- saturated trapping
- two types of defects:
 - dislocations
 - vacancy clusters

$$S = (1 - \eta_{cl}) S_{disl} + \eta_{cl} S_{cl}$$

$$W = (1 - \eta_{cl}) W_{disl} + \eta_{cl} W_{cl}$$

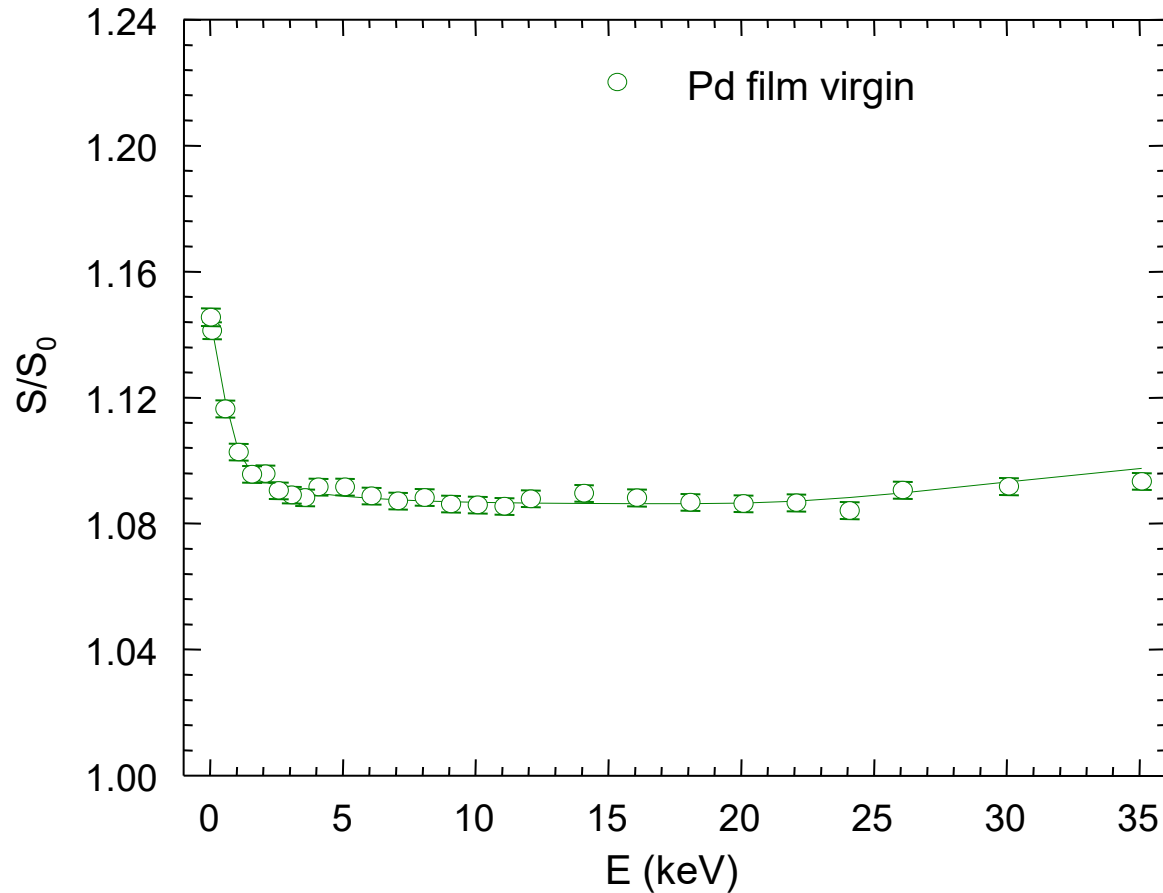
vacancy clusters

$$R \equiv \frac{S - S_d}{W - W_d} = \text{konst}$$

Pd films

Pd film, thickness 1080 nm, virgin state

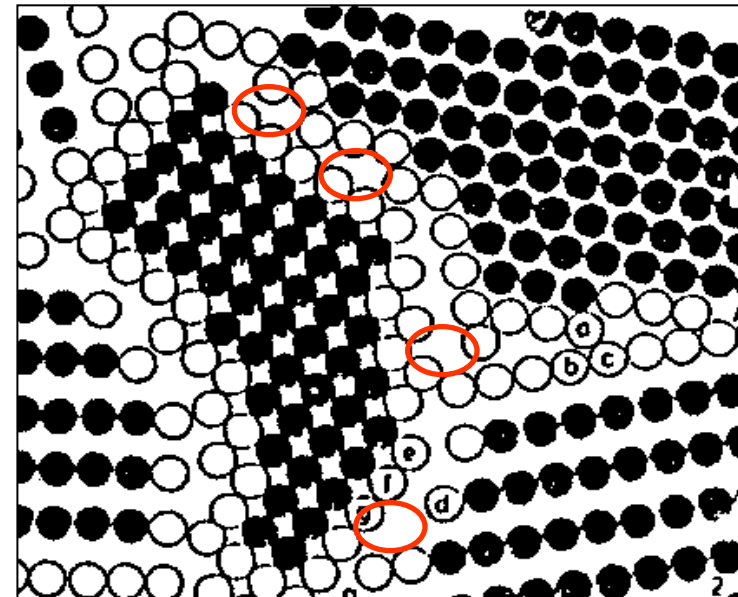
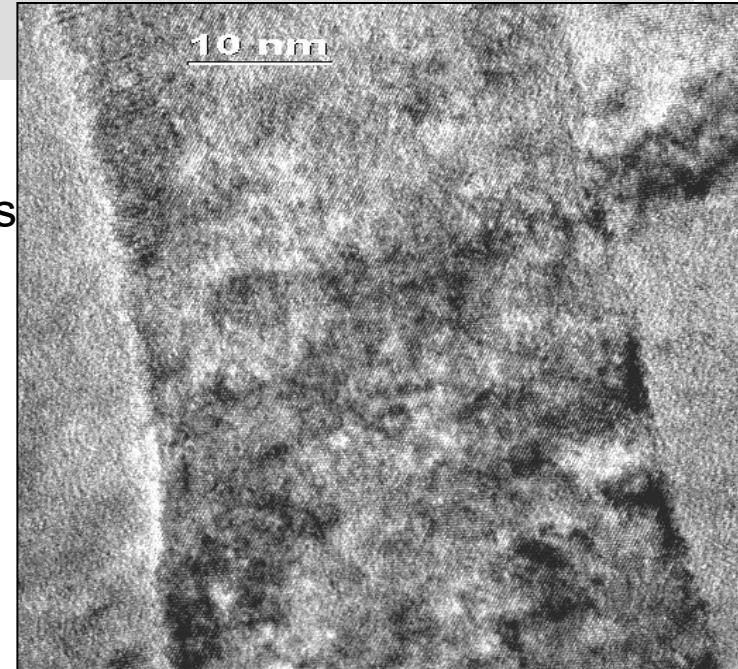
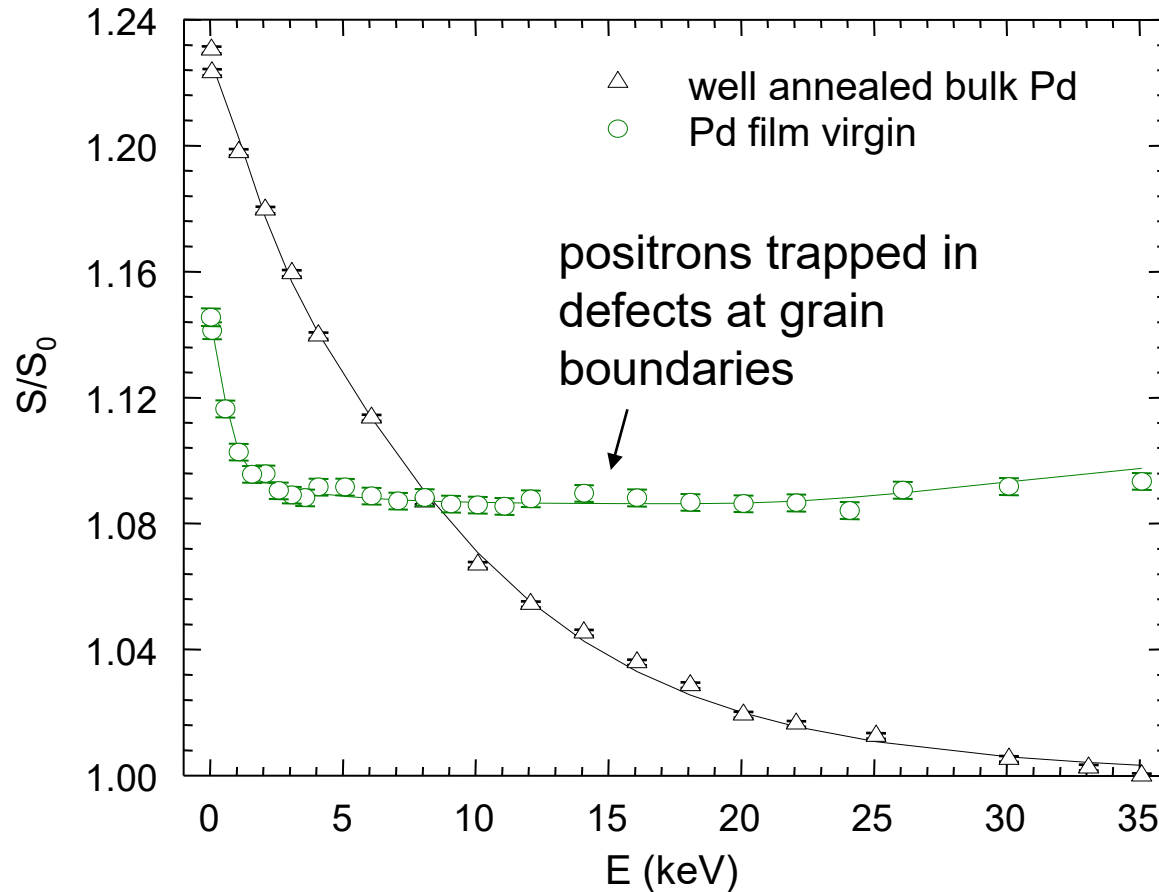
- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate
- thin film, Pd layer: $L_+ = (41 \pm 7)$ nm



Pd films

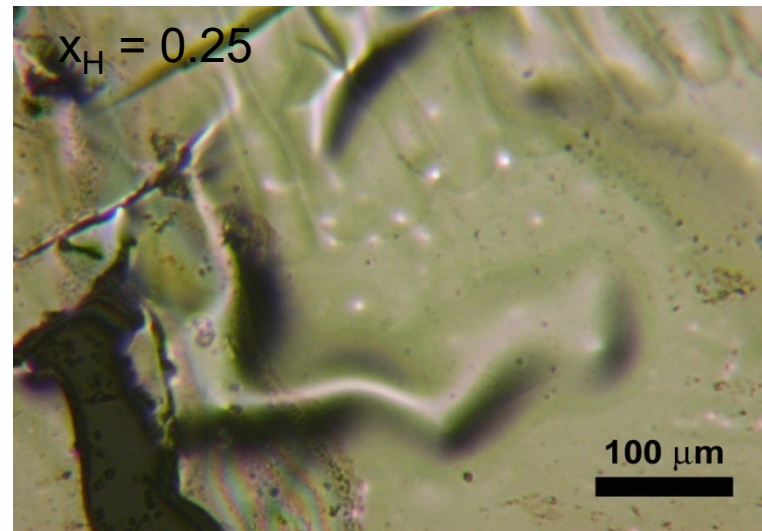
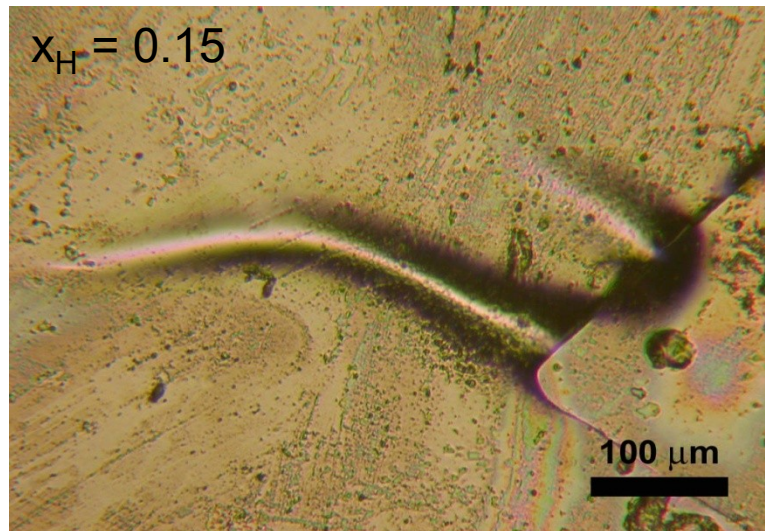
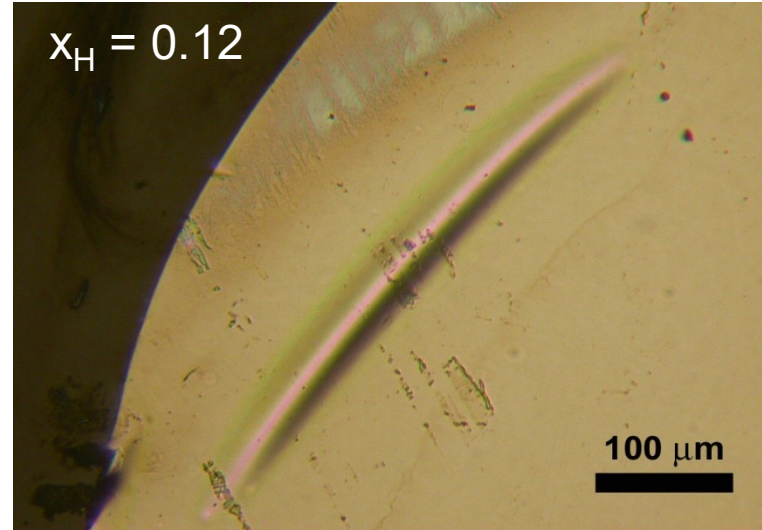
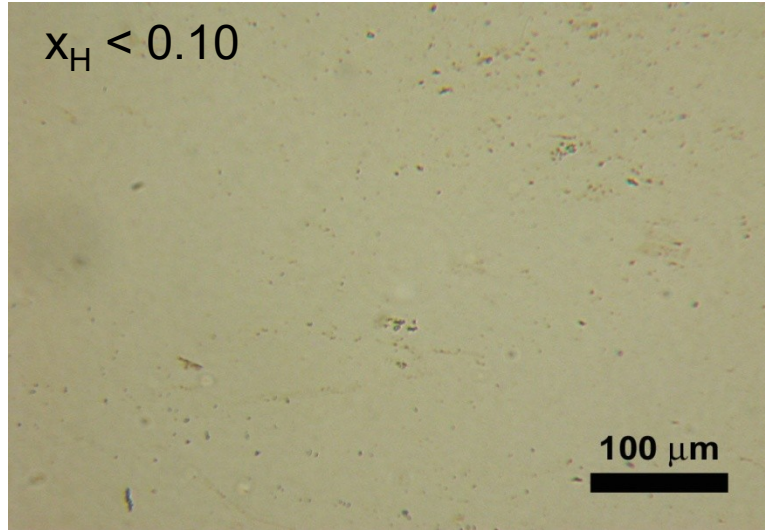
Pd film, thickness 1080 nm, virgin state

- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate
- thin film, Pd layer: $L_+ = (41 \pm 7)$ nm
- well annealed bulk Pd layer: $L_+ = (151 \pm 4)$ nm



Hydrogen-induced buckling

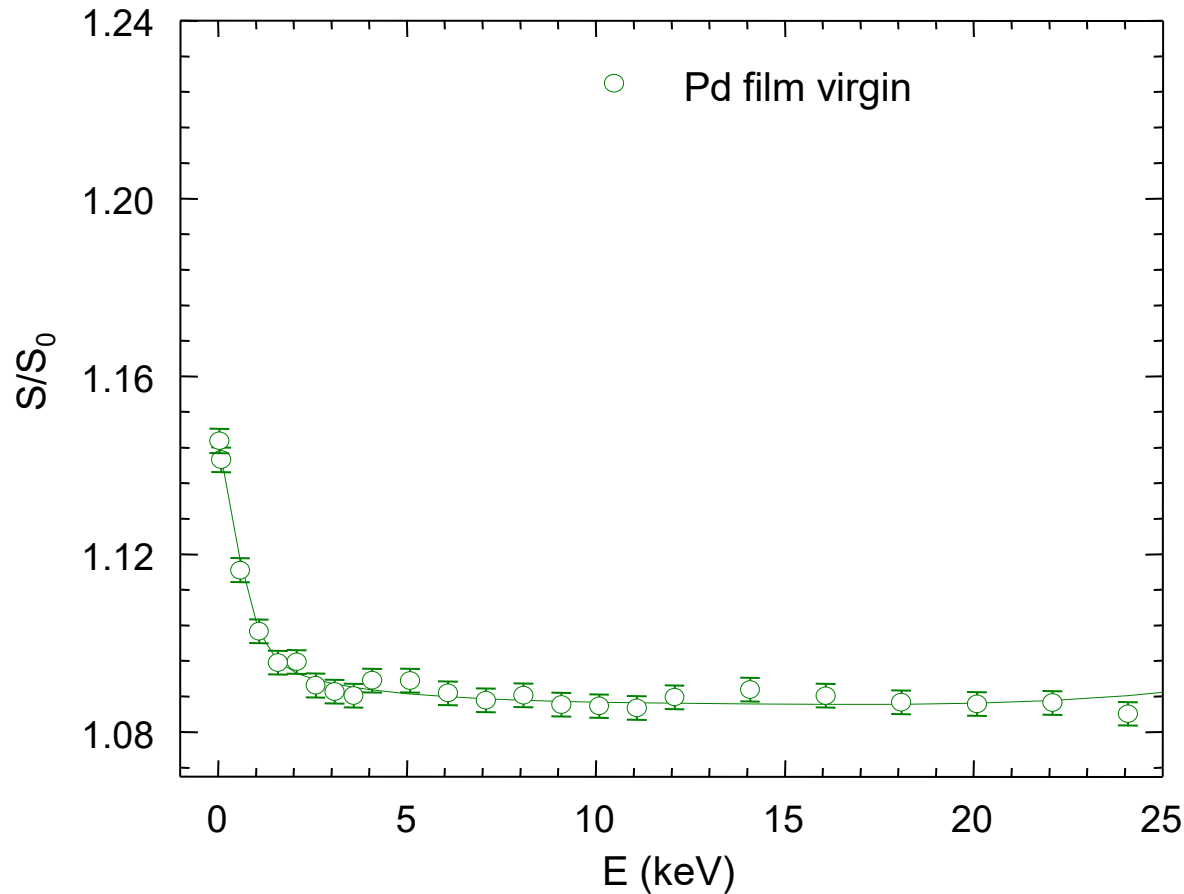
Pd film, thickness 1080 nm, step-by-step loaded with hydrogen



Pd films

Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

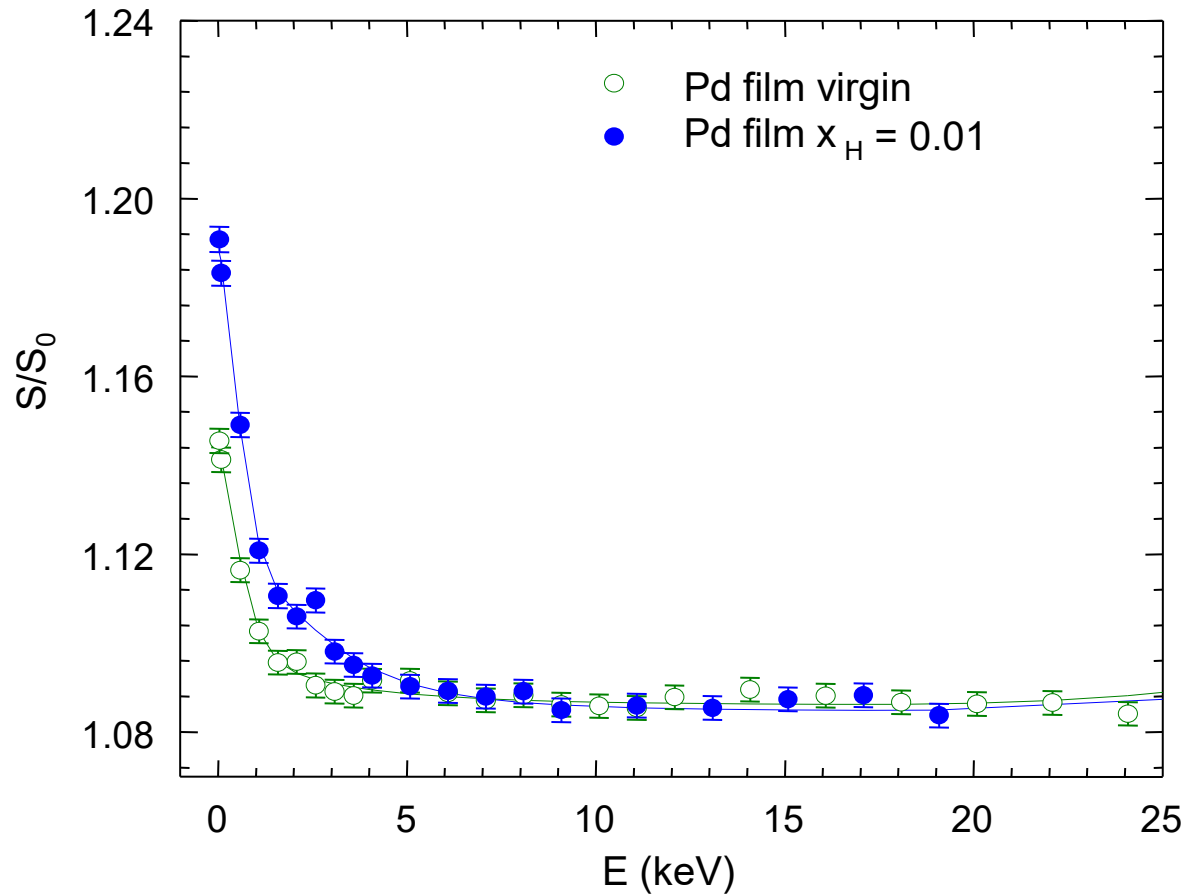
- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate



Pd films

Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

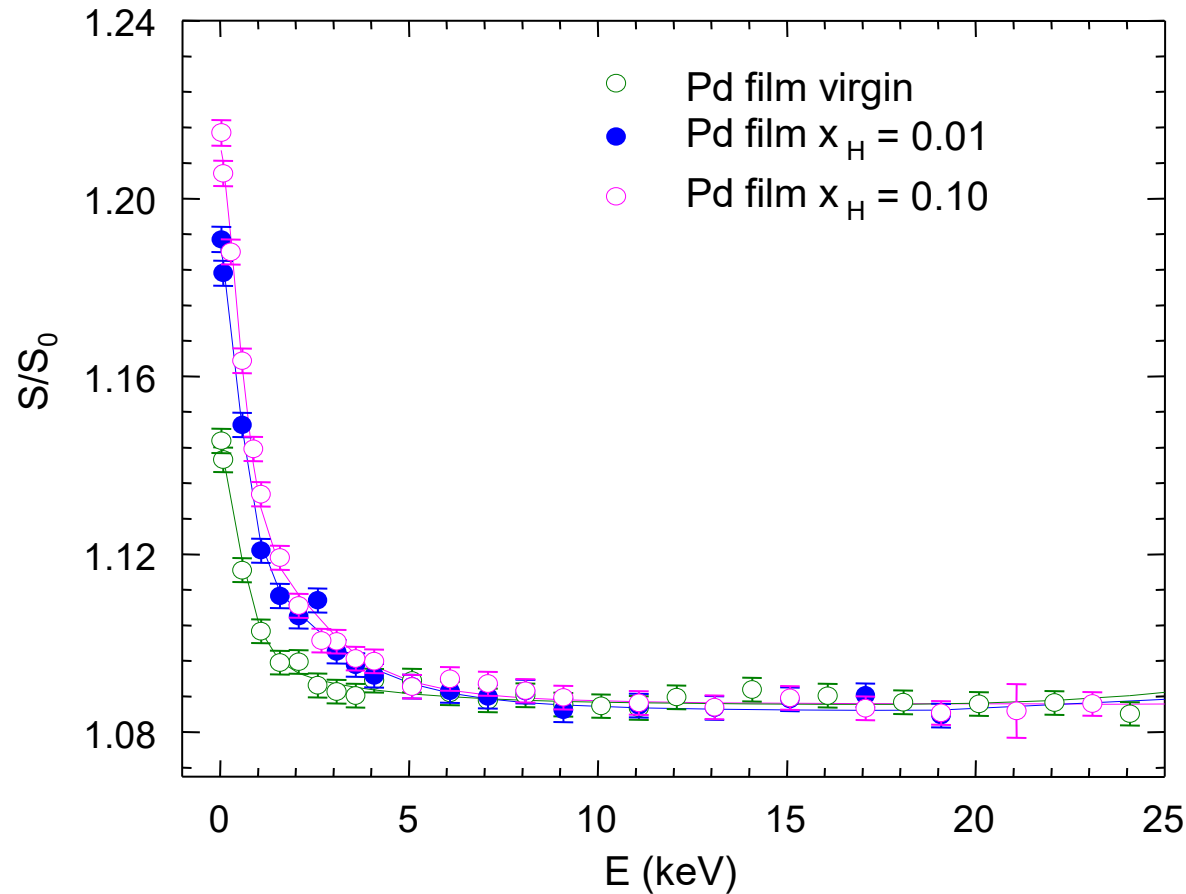
- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate



Pd films

Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

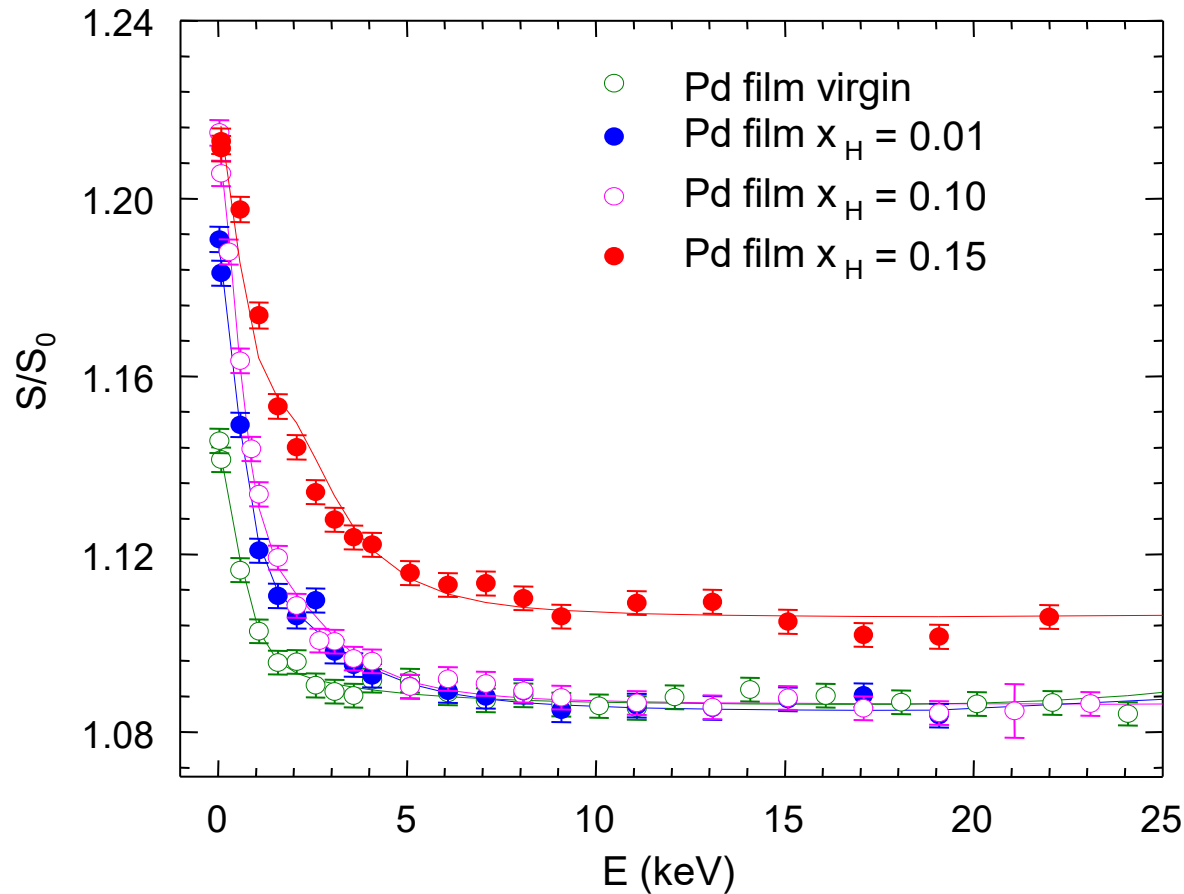
- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate



Hydrogen loaded Pd films

Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

- VEPFIT (model 5) two layers: (i) Pd film, (ii) sapphire substrate

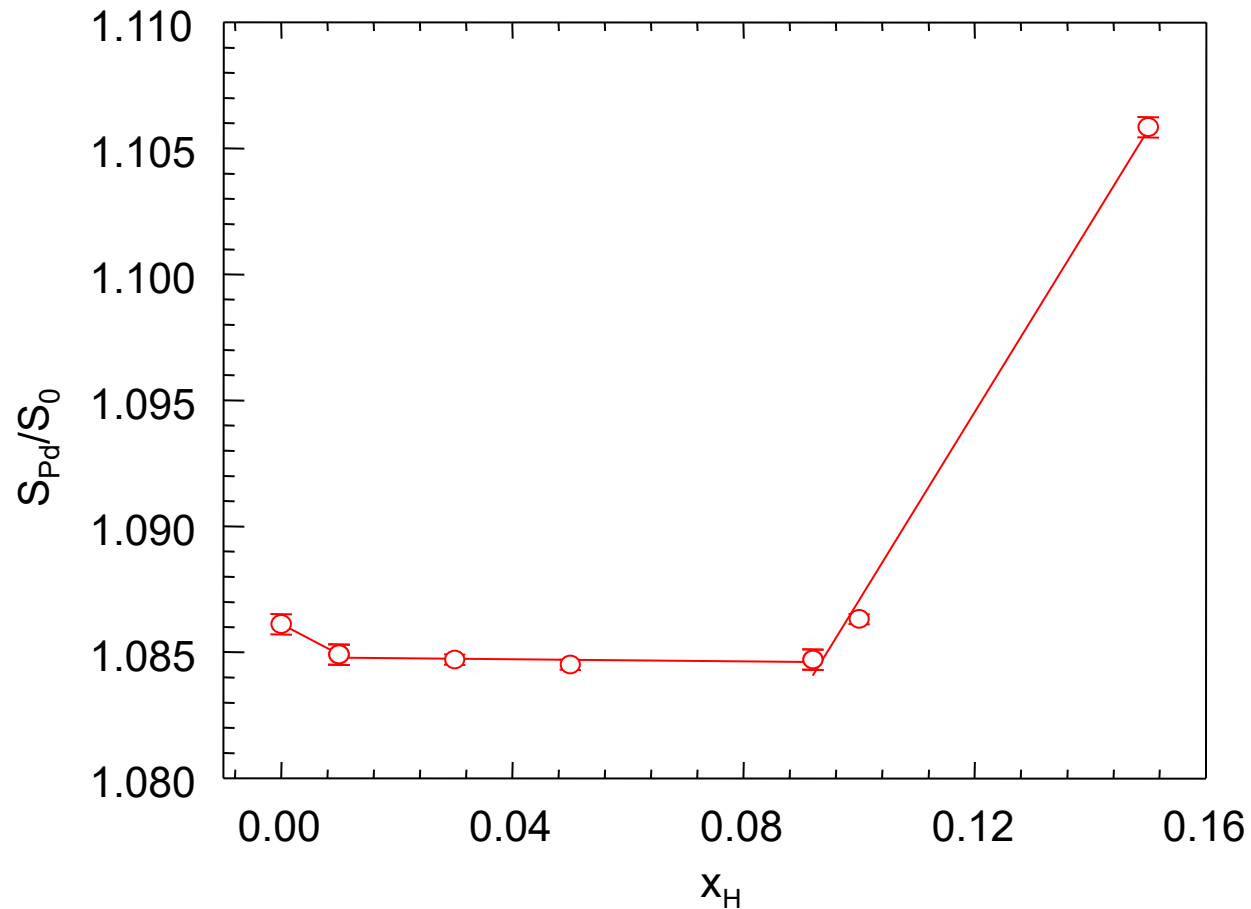


$x_H = 0.15$

Hydrogen loaded Pd films

Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

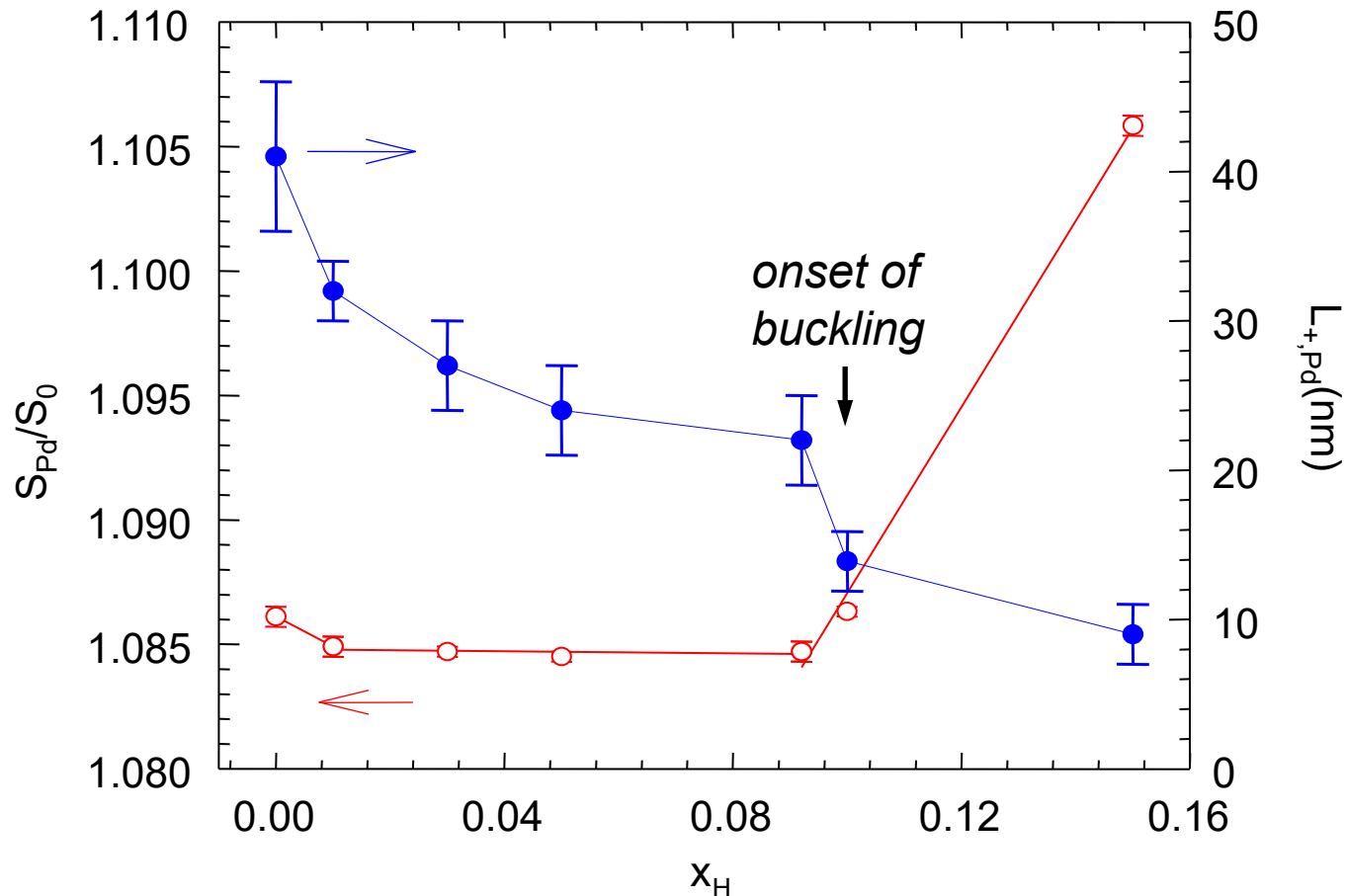
- S_{Pd} - parameter for the Pd layer



Hydrogen loaded Pd films

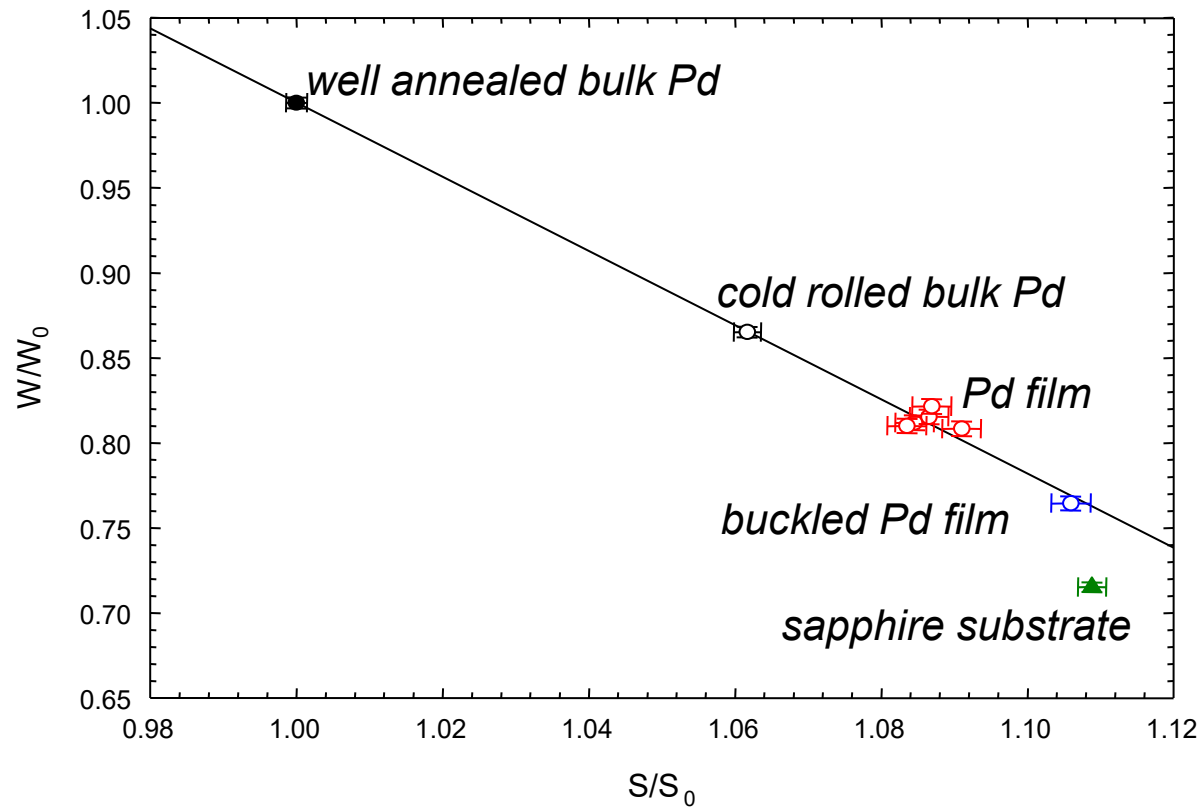
Pd film, thickness 1080 nm, step-by-step loaded with hydrogen

- S_{Pd} - parameter for the Pd layer
- $L_{+,Pd}$ – positron diffusion length for the Pd layer



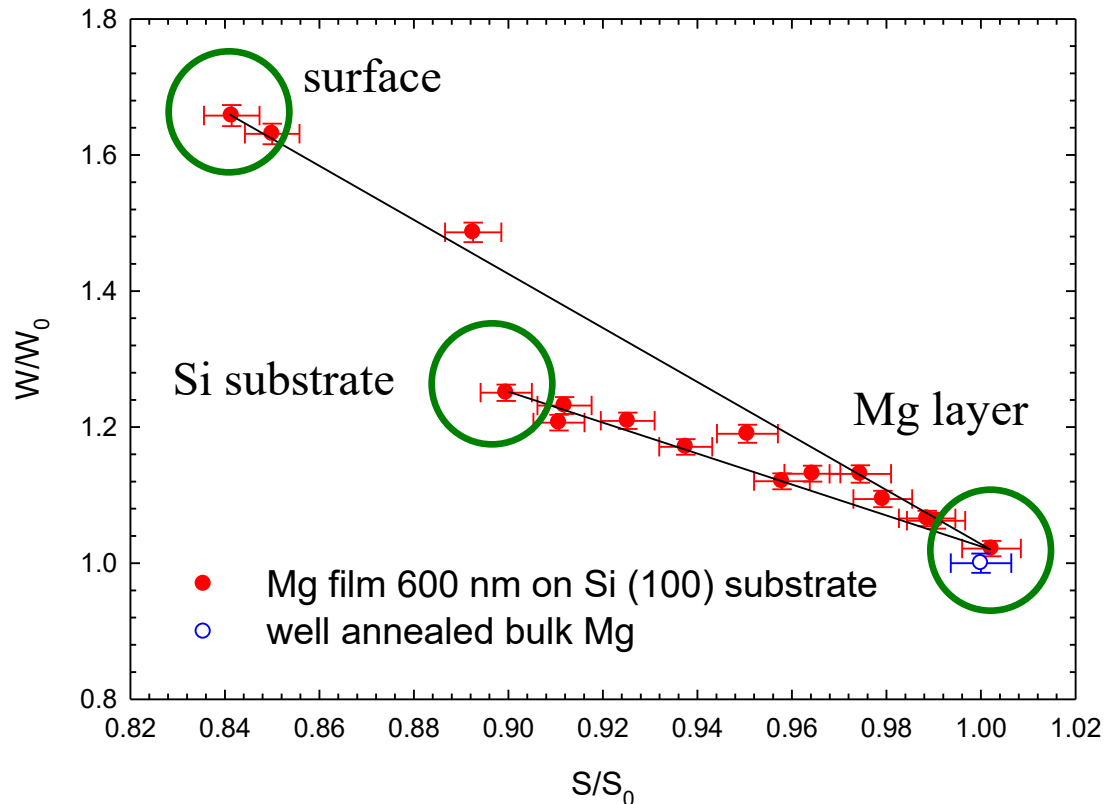
Hydrogen loaded Pd films

Pd film, thickness 1080 nm × bulk Pd



S-W plot

Mg film (600 nm) deposited on Si (100) substrate



- M – number of layers
- N_l – number of defects in l -th layer

$$\eta_{surf}(E) + \sum_{l=1}^M F_l(E) = 1$$

$$\eta_{B,l} + \sum_{i=1}^{N_l} \eta_{D,i,l} = 1$$

$$S(E) = \eta_{surf}(E)S_{surf} + \sum_{l=1}^M F_l(E) \left(\eta_{B,l}S_{B,l} + \sum_{i=1}^{N_l} \eta_{D,i,l}S_{D,i,l} \right)$$

